Information collection	Number of respondents	Frequency of response	Responses per annum	Burden hours per response	Annual burden hours	Hourly cost per response	Annual cost
Quality control of Early Payment Defaults							
(EPDs)	1,463	26	38,038	.25	9,509.50	\$53.22	\$506,095.59
Quality control of loan originationsQuality control through	1,463	16	23,408	.25	5,852	53.22	311,443.44
lender self-reports	261	24	6,264	.25	1,566	53.22	83,342.52

### B. Solicitation of Public Comment

This notice is soliciting comments from members of the public and affected parties concerning the collection of information described in Section A on the following:

- (1) Whether the proposed collection of information is necessary for the proper performance of the functions of the agency, including whether the information will have practical utility;
- (2) The accuracy of the agency's estimate of the burden of the proposed collection of information;
- (3) Ways to enhance the quality, utility, and clarity of the information to be collected: and
- (4) Ways to minimize the burden of the collection of information on those who are to respond; including through the use of appropriate automated collection techniques or other forms of information technology, e.g., permitting electronic submission of responses.

HUD encourages interested parties to submit comment in response to these questions.

### C. Authority

Section 3507 of the Paperwork Reduction Act of 1995, 44 U.S.C. chapter 35.

## Jeffrey D. Little,

General Deputy Assistant Secretary for Housing.

[FR Doc. 2023–15819 Filed 7–26–23; 8:45 am]

# DEPARTMENT OF HOUSING AND URBAN DEVELOPMENT

[Docket No. FR-6413-N-01]

## Preview of the FY 2023 Housing Counseling Program Homeownership Initiative; Notice of Funding Opportunity

**AGENCY:** Office of Housing Counseling, Department of Housing and Urban Development (HUD).

**ACTION:** Notice.

**SUMMARY:** Through this notice, HUD is announcing the publication of a preview of the Fiscal Year (FY) 2023 Homeownership Initiative Notice of

Funding Opportunity (NOFO) in advance of publication on *Grants.gov*. HUD is making this preview available to allow interested applicants to review the preview of the NOFO, submit questions, and prepare applications. HUD intends to publish the NOFO and allow submission of applications in FY 2024.

#### FOR FURTHER INFORMATION CONTACT:

Melissa Noe, Housing Program Specialist, Policy and Grant Administration, Office of Housing Counseling, Department of Housing and Urban Development, 77 W Jackson Blvd., Room 2301, Chicago, IL 60604; telephone number 312-913-8648 (this is not a toll-free number); email housing.counseling@hud.gov. HUD welcomes and is prepared to receive calls from individuals who are deaf or hard of hearing, as well as individuals with speech or communication disabilities. To learn more about how to make an accessible telephone call, please visit: https://www.fcc.gov/ consumers/guides/telecommunicationsrelay-service-trs.

SUPPLEMENTARY INFORMATION: HUD is publishing a preview of the FY 2023 Homeownership Initiative NOFO to give interested applicants time to prepare their applications prior to the opening of the application period. During this preview, the FY 2023 Homeownership Initiative NOFO Preview is available on HUD's website at the following URL: https://www.hud.gov/grants.

This NOFO Preview is subject to change. While HUD does not intend to make substantive changes at this point, applicants should consider the NOFO published on *Grants.gov* to be the official version.

HUD will not accept applications during the preview period. However, during this preview, interested applicants may submit questions on the NOFO Preview to the following email address: housing.counseling@hud.gov, using the email subject line: FY 2023 Homeownership Initiative NOFO. Interested applicants may also conduct the required registration activities for the System for Award Management (SAM), Unique Entity Identifier (UEI),

and *Grants.gov* (see Section IV.C. of the NOFO Preview).

Interested applicants are strongly encouraged to thoroughly review and prepare for the NOFO, by carefully examining the NOFO Preview, with particular attention to the fixed amount award submission requirements and rating factor responses.

HUD anticipates that the FY 2023 Homeownership Initiative NOFO will be published on *Grants.gov* in FY 2024. The publication of the FY 2023 Homeownership Initiative NOFO on *Grants.gov* will signal the opening of the application period. The application period will be open for 30 days. Applications must be submitted through *Grants.gov*.

HUD will not accept requests for a waiver of electronic submission requirements during the preview period. Such requests may only be submitted once the NOFO has been published on *Grants.gov* (see Section IV.A. of the NOFO Preview).

### David Berenbaum,

Deputy Assistant Secretary for Housing Counseling.

[FR Doc. 2023–15902 Filed 7–26–23; 8:45 am] BILLING CODE 4210–67–P

## **DEPARTMENT OF THE INTERIOR**

## **Bureau of Land Management**

[BLM CO FRN MO4500172670]

## Notice of Filing of Plats of Survey, Colorado

**AGENCY:** Bureau of Land Management, Interior.

**ACTION:** Notice of official filing.

**SUMMARY:** The plats of survey of the following described lands are scheduled to be officially filed in the Bureau of Land Management (BLM), Colorado State Office, Lakewood, Colorado, 30 calendar days from the date of this publication. The surveys, which were executed at the request of the U.S. Forest Service, are necessary for the management of these lands.

**DATES:** Unless there are protests of this action, the plats described in this notice will be filed on August 28, 2023.

ADDRESSES: You may submit written protests to the BLM Colorado State Office, Cadastral Survey, P.O. Box 151029, Lakewood, CO 80215.

#### FOR FURTHER INFORMATION CONTACT:

David W. Ginther, Chief Cadastral Surveyor for Colorado, telephone: (970) 826–5064; email: dginther@blm.gov. Individuals in the United States who are deaf, deafblind, hard of hearing, or have a speech disability may dial 711 (TTY, TDD, or TeleBraille) to access telecommunications relay services. Individuals outside the United States should use the relay services offered within their country to make international calls to the point-of-contact in the United States.

**SUPPLEMENTARY INFORMATION:** The plat and field notes of the dependent resurvey and survey in Townships 32 North, Ranges 6 and 7 East, New Mexico Principal Meridian, Colorado, were accepted on April 27, 2023.

The plat incorporating the field notes of the remonumentation of a corner in Township 5 North, Range 72 West, Sixth Principal Meridian, Colorado, was accepted on May 19, 2023.

The plat incorporating the field notes of the remonumentation of a corner in Township 10 North, Range 73 West, Sixth Principal Meridian, Colorado, was accepted on May 19, 2023.

The plat and field notes of the corrective dependent resurvey and survey in Township 9 North, Range74 West, Sixth Principal Meridian, Colorado, were accepted on June 6, 2023.

The plat and field notes of the dependent resurvey and subdivision of section 14 in Township 11 North, Range 73 West, Sixth Principal Meridian, Colorado, were accepted on June 15, 2023.

The plat and field notes of the dependent resurvey in Township 10 North, Range 72 West, Sixth Principal Meridian, Colorado, were accepted on July 7, 2023.

A person or party who wishes to protest any of the above surveys must file a written notice of protest within 30 calendar days from the date of this publication at the address listed in the ADDRESSES section of this notice. A statement of reasons for the protest may be filed with the notice of protest and must be filed within 30 calendar days after the protest is filed. If a protest against the survey is received prior to the date of official filing, the filing will be stayed pending consideration of the protest. A plat will not be officially filed

until the day after all protests have been dismissed or otherwise resolved.

Before including your address, phone number, email address, or other personal identifying information in your protest, please be aware that your entire protest, including your personal identifying information, may be made publicly available at any time. While you can ask us in your comment to withhold your personal identifying information from public review, we cannot guarantee that we will be able to do so.

(Authority: 43 U.S.C. Chap. 3)

#### David W. Ginther.

Chief Cadastral Surveyor.

[FR Doc. 2023-15859 Filed 7-26-23; 8:45 am]

BILLING CODE 4331-16-P

# INTERNATIONAL TRADE COMMISSION

[Investigation No. 337-TA-1367]

Certain Electronic Devices and Semiconductor Devices Having Wireless Communication Capabilities and Components Thereof; Institution of Investigation

**AGENCY:** U.S. International Trade Commission.

**ACTION:** Notice.

**SUMMARY:** Notice is hereby given that a complaint was filed with the U.S. International Trade Commission on June 21, 2023, under section 337 of the Tariff Act of 1930, as amended, on behalf of Bell Northern Research, LLC of Chicago, Illinois. Supplements were filed on July 3 and 11, 2023. The complaint, as supplemented, alleges violations of section 337 based upon the importation into the United States, the sale for importation, and the sale within the United States after importation of certain electronic devices and semiconductor devices having wireless communication capabilities and components thereof by reason of the infringement of certain claims of U.S. Patent No. 7,564,914 ("the '914 patent"); U.S. Patent No. RE 48,629 ("the '629 patent"); and U.S. Patent No. 8,416,862 ("the '862 patent"). The complaint further alleges that an industry in the United States exists as required by the applicable Federal Statute. The complainant requests that the Commission institute an investigation and, after the investigation, issue a limited exclusion order and cease and desist orders.

**ADDRESSES:** The complaint, except for any confidential information contained

therein, may be viewed on the Commission's electronic docket (EDIS) at https://edis.usitc.gov. For help accessing EDIS, please email EDIS3Help@usitc.gov. Hearing impaired individuals are advised that information on this matter can be obtained by contacting the Commission's TDD terminal on (202) 205–1810. Persons with mobility impairments who will need special assistance in gaining access to the Commission should contact the Office of the Secretary at (202) 205– 2000. General information concerning the Commission may also be obtained by accessing its internet server at https://www.usitc.gov.

## FOR FURTHER INFORMATION CONTACT:

Pathenia M. Proctor, The Office of Unfair Import Investigations, U.S. International Trade Commission, telephone (202) 205–2560.

### SUPPLEMENTARY INFORMATION:

Authority: The authority for institution of this investigation is contained in section 337 of the Tariff Act of 1930, as amended, 19 U.S.C. 1337, and in section 210.10 of the Commission's Rules of Practice and Procedure, 19 CFR 210.10 (2023).

Scope of Investigation: Having considered the complaint, the U.S. International Trade Commission, on July 21, 2023, ordered that—

- (1) Pursuant to subsection (b) of section 337 of the Tariff Act of 1930, as amended, an investigation be instituted to determine whether there is a violation of subsection (a)(1)(B) of section 337 in the importation into the United States, the sale for importation, or the sale within the United States after importation of certain products identified in paragraph (2) by reason of infringement of one or more of claims 13, 14, 17, 21, and 22 of the '914 patent; claims 1, 8–11, 13, 14, 19, 20, and 27 of the '629 patent; and claims 1-4 and 9-12 of the '862 patent, and whether an industry in the United States exists as required by subsection (a)(2) of section
- (2) Pursuant to section 210.10(b)(1) of the Commission's Rules of Practice and Procedure, 19 CFR 210.10(b)(1), the plain language description of the accused products or category of accused products, which defines the scope of the investigation, is "semiconductor devices, and specifically undiced wafers, diced wafers, packaged chips and chipsets both attached and unattached to printed circuit boards and modules; personal and tablet computers; and routers, gateways, and networking devices having wireless communication capabilities, and components thereof";